

PCB O-leading:

PCB O-leading is a standard specification for PCB manufacturing. It defines the minimum and maximum values for various parameters such as hole diameter, hole spacing, and hole depth. The standard is based on the IPC-6013 standard. The standard is used to ensure that PCBs are manufactured to the same quality and consistency. The standard is used to ensure that PCBs are manufactured to the same quality and consistency. The standard is used to ensure that PCBs are manufactured to the same quality and consistency.

COPPER PLATE HOLES MINIMUM .025 AVG .020MIN .. HOLES MAY NOT NOT PLUGGED
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Material	FR-4 (Standard))	Thickness	0.50Z-50Z
Min. Hole Dia.	0.2mm	Max. Hole Dia.	0.2mm
Min. Hole Spacing	0.1mm	Max. Hole Spacing	5mm
Surface Finish	OSP / HASL	Min. Thickness	0.05mm
Quality Standard	ISO9001 / UL / SGS	Q / Quantity	10PCS-100PCS
Weight	0.01kg -5kg	Lead Time	10 days
Min. Hole Depth	0.2mm	Max. Hole Depth	0.2mm
Min. Hole Diameter	0.1mm	Max. Hole Diameter	\$ 0.1 - \$ 10
Min. Hole Spacing	0.1mm	Max. Hole Spacing	0.01m3-10m3



www.o-leading.com

PCB 16 Layers & HDI PCB

<p>16 Layers PCB HDI PCB</p>	<p>16 Layers PCB HDI PCB</p>
<p>7-12days</p>	<p>7-12days</p>

